1 Electrical ratings

Table 2. Ab	solute max	kimum r	ratinas
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Symbol	Parameter	Value	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)	600	V
I _C ⁽¹⁾	Continuous collector current at $T_C = 25 \ ^{\circ}C$	70	Α
I _C ⁽¹⁾	Continuous collector current at $T_C = 100 \ ^{\circ}C$	45	Α
I _{CP} ⁽²⁾	Pulsed collector current	150	Α
I _{CL} ⁽³⁾	Turn-off latching current	80	Α
V _{GE}	Gate-emitter voltage	± 20	V
١ _F	Diode RMS forward current at $T_C = 25 \text{ °C}$	30	Α
I _{FSM}	Surge not repetitive forward current t _p = 10 ms sinusoidal	120	Α
P _{TOT}	Total dissipation at $T_C = 25 \ ^{\circ}C$	250	W
T _{stg}	Storage temperature	– 55 to 150	°C
Тj	Operating junction temperature	- 55 10 150	

1. Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

2. Pulse width limited by maximum junction temperature and turn-off within RBSOA

3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_G = 10 $\Omega,\,T_J$ = 150 $^{\circ}C$

Symbol Parameter		Value	Unit
Thermal resistance junction-case IGBT		0.5	°C/W
R _{thj-case}	Thermal resistance junction-case diode	1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50	°C/W



2 Electrical characteristics

 $(T_J = 25 \ ^{\circ}C \text{ unless otherwise specified})$

Table 4. St	atic
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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	V _{GE} = 15 V, I _C = 30 A V _{GE} = 15V, I _C = 30 A,T _J = 125 °C		1.65	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}, I_C = 1 \text{ mA}$	3.75		5.75	V
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V, T _J = 125 °C			500 5	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA

Table 5. V_{CE(sat)} classification

Symbol	Parameter	Group	Va	lue	Unit
Symbol	Falanelei	Group	Min.	Max.	Unit
		A	1.68	1.92	
V _{CE(sat)}	ollector-emitter saturation voltage _{ЭF} = 15 V, I _C = 30 A	В	1.88	2.17	V
		С	2.13	2.50	

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0	-	2900 260 55	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	V _{CE} = 400 V, I _C = 30 A, V _{GE} = 15 V, <i>Figure 17</i>	-	160 17 65	-	nC nC nC



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope		-	30 12 2600	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 400 \text{ V}, I_C = 30 \text{ A}$ $R_G = 6.8 \Omega, V_{GE} = 15 \text{ V},$ $T_J = 125 \text{ °C} (Figure 16)$	-	30 14 2200	-	ns ns A/µs
$t_r(V_{off}) \ t_d(_{off}) \ t_f$	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 400 \text{ V}, I_{C} = 30 \text{ A}, \\ R_{G} = 6.8 \Omega, V_{GE} = 15 \text{ V} \\ (Figure \ 16)$	-	30 145 50	-	ns ns ns
t _r (V _{off}) t _{d(off}) t _f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 400 \text{ V}, I_C = 30 \text{ A},$ $R_G = 6.8 \Omega, V_{GE} = 15 \text{ V},$ $T_J = 125 \text{ °C}$ <i>(Figure 16)</i>	-	47 185 65	-	ns ns ns

 Table 7.
 Switching on/off (inductive load)

Table 8. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{on} ⁽¹⁾ E _{off}	Turn-on switching losses Turn-off switching losses	V_{CC} = 400 V, I _C = 30 A R _G = 6.8 Ω, V _{GE} = 15 V,	-	300 330		μJ μJ
E _{ts} E _{on} ⁽¹⁾	Total switching losses Turn-on switching losses	(<i>Figure 18</i>) V _{CC} = 400 V, I _C = 30 A		630 550		μJ μJ
E _{off} E _{ts}	Turn-off switching losses Total switching losses	$R_{G} = 6.8 \Omega$, $V_{GE} = 15 V$, $T_{J} = 125 °C (Figure 18)$	-	550 1100	800	μJ μJ

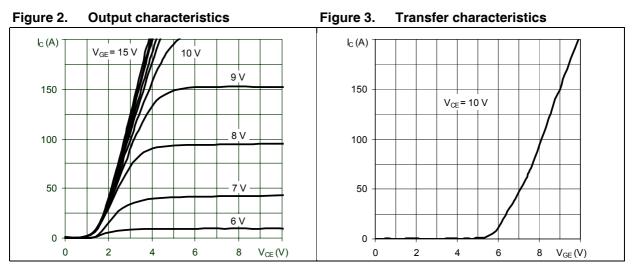
 Eon is the tun-on losses when a typical diode is used in the test circuit in *Figure 18*. If the IGBT is offered in a package with a co-pak diode, the co-pack diode is used as external diode. IGBTs & Diode are at the same temperature (25 °C and 125 °C). Eon include diode recovery energy.

Table 9. Collector-emitter diode

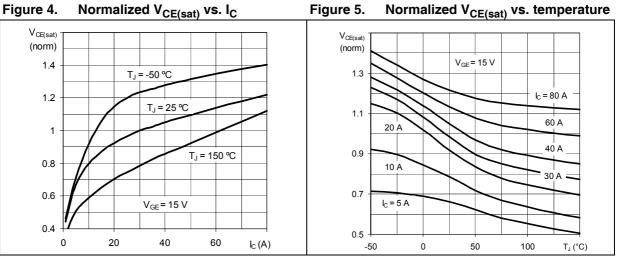
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _F	Forward on-voltage	I _F = 30 A I _F = 30 A, T _J = 125 °C	-	2 1.65	2.5	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _F = 30 A,V _R = 50 V, di/dt = 100 A/μs <i>(see Figure 19)</i>	-	55 110 3	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$\begin{split} I_F &= 30 \text{ A}, V_R = 50 \text{ V}, \\ \text{di/dt} &= 100 \text{ A/}\mu\text{s} \\ T_J &= 125 \ ^\circ\text{C}, \ (\text{see Figure 19}) \end{split}$	-	140 400 5.5	-	ns nC A



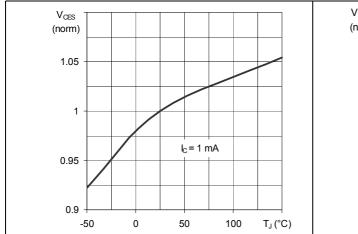
Electrical characteristics (curves) 2.1



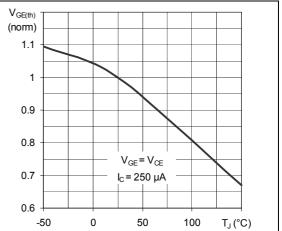




Normalized breakdown voltage vs. Figure 7. Figure 6. temperature

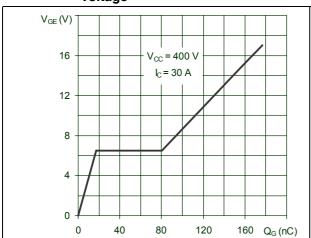


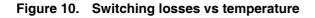
Normalized gate threshold voltage vs. temperature



57

Figure 8. Gate charge vs. gate-emitter voltage





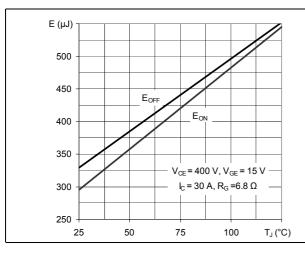


Figure 12. Switching losses vs. collector current

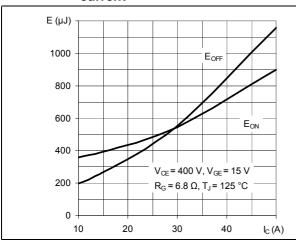


Figure 9. Capacitance variations

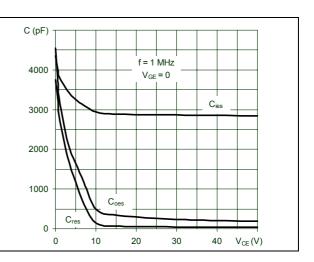
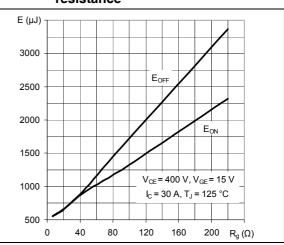
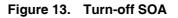
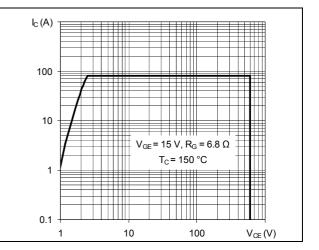


Figure 11. Switching losses vs. gate resistance







6/12

Doc ID 15593 Rev 3



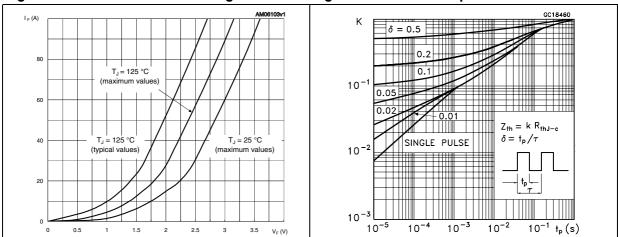
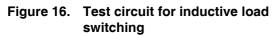


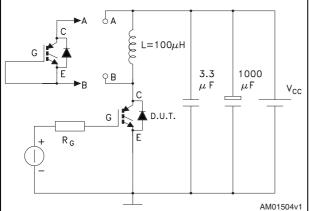
Figure 14. Diode forward on voltage

Figure 15. Thermal impedance



3 Test circuits





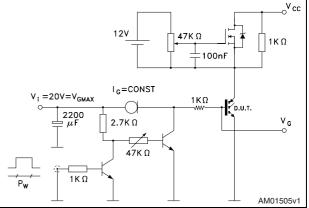
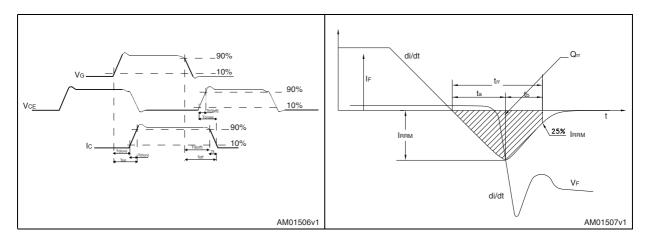


Figure 17. Gate charge test circuit









4 Package mechanical data

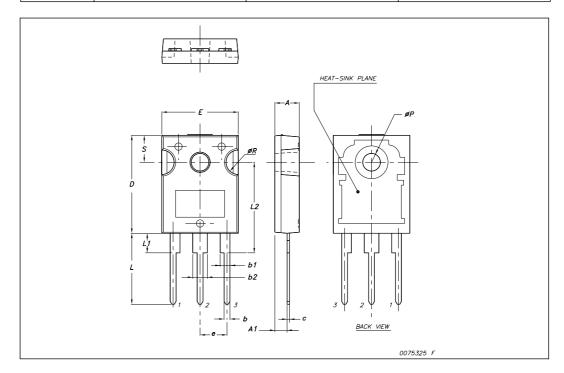
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TO-247 Mechanical data				
Dim.	mm.			
	Min.	Тур	Max.	
А	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
с	0.40		0.80	
D	19.85		20.15	
E	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
øP	3.55		3.65	
øR	4.50		5.50	
S		5.50		



Doc ID 15593 Rev 3



5 Revision history

Table 10.	Document revision history
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Date	Revision	Changes
16-Apr-2009	1	Initial release.
04-Aug-2009	2	 Modified I_C value on Test conditions <i>Table 4</i> Modified R_G value on Test conditions <i>Table 7</i> and <i>Table 8</i>
28-Apr-2010 3		 Document status promoted from preliminary data to datasheet Inserted V_{CE(sat)} grouping A, B and C (see <i>Table 5</i>) Inserted dynamic parameters on <i>Table 5</i>, <i>Table 6</i> and <i>Table 7</i> Inserted <i>Section 2.1: Electrical characteristics (curves)</i>



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12/12

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